

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5306317

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	DANIEL H. KIM	07/06/2012
RECEIVING PARTY DATA		
Name:	THE BOARD OF TRUSTEES OF THE LELAND STANFORD JUNIOR UNIVERSITY	
Street Address:	BUILDING 170, THIRD FLOOR, MAIN QUAD, P.O. BOX 20386	
Internal Address:	OFFICE OF THE GENERAL COUNSEL	
City:	STANFORD	
State/Country:	CALIFORNIA	
Postal Code:	94305	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15861592
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	10088-728.302	
NAME OF SUBMITTER:	JENNIFER MARCELINO	
SIGNATURE:	/W. Benjamin Glenn, Reg. No. 44,713/	
DATE SIGNED:	01/02/2019	
Total Attachments: 3		
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RECORDATION FORM COVER SHEET
PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE

PATENT AND TRADEMARK OFFICE

TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):

(1) Daniel H. KIM

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: **THE BOARD OF TRUSTEES OF THE
LELAND STANFORD JUNIOR UNIVERSITY
Office of the General Counsel
Building 170, Third Floor, Main Quad
P.O. Box 20386
Stanford, CA 94305**

3. Nature of Conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

EXECUTION DATE(S): (1) 07/06/2012

Name and address of receiving party(ies):

Name:

Street Address:

City: State: Zip:

Country:

Additional name(s) & address(es) attached?

☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s) – **15/861,592**

Title: **SELECTIVE STIMULATION TO MODULATE
THE SYMPATHETIC NERVOUS SYSTEM**

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

**W. Benjamin Glenn
Shay Glenn LLP
2755 Campus Drive, Suite 210
San Mateo, CA 94403**

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h)(1)): \$0.00

☒ None required. Please charge fees to **Deposit Account
No. 50-4050.**

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

W. Benjamin Glenn, Reg. No. 44,713**/W. Benjamin Glenn/****January 2, 2019**

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: **3**

ASSIGNMENT OF PATENT APPLICATION**Docket Number: 10088-728.200
SM-03010US / S04-231**

This Assignment of Patent Application is between: **Daniel H. Kim** of Houston, TX, (hereinafter referred to as "Inventor") and **The Board of Trustees of The Leland Stanford Junior University** having corporate powers under the laws of the State of California, having a place of business at 1705 El Camino Real, Palo Alto, California, 94306-1106, (hereinafter termed "Assignee").

WHEREAS Inventor has invented certain new and useful improvements in:

"SELECTIVE STIMULATION TO MODULATE THE SYMPATHETIC NERVOUS SYSTEM"

for which an application for the United States Patent was filed on **April 27, 2012**, Application No. **13/458,697**.

WHEREAS, Assignee is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of the said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contest, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his heirs, legal representatives and assigns.

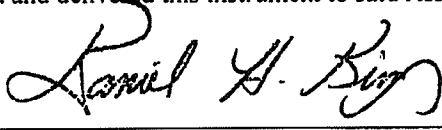
4. Said Inventor hereby warrants and represents that he has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

ASSIGNMENT OF PATENT APPLICATION

Docket Number: 10088-728.200
SM-03010US / S04-231

IN WITNESS WHEREOF, said Inventor has executed and delivered this instrument to said Assignee:

7-6-12
Date


Daniel H. Kim